These assemblies are ESD sensitive, ESD precautions shall be observed.
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #</th>
<th>TID-00445</th>
<th>REV</th>
<th>E2</th>
<th>SUN REV</th>
<th>Notes</th>
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**Layer Name:** NG Assembly Bottom

**Plot Name:** Bottom Assembly Drawing

**Generated:** 12/3/2015 2:59:38 PM

**Note:** Components marked 'DNP' should not be populated.
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